



Fast Avalanche Sinterglass Diode

Features

- · Glass passivated junction
- Hermetically sealed package
- · Low reverse current
- · Soft recovery characteristics

Applications

Fast rectification and switching diode

Mechanical Data

Case: Sintered glass case, SOD 57

Terminals: Plated axial leads, solderable per MIL- Mounting Position: Any

STD-750, Method 2026 Weight: 370 mg, (max. 500 mg)

Polarity: Color band denotes cathode end



Part	Type differentiation	Package
BYT52A	V _R = 50 V; I _{FAV} = 1.4 A	SOD57
BYT52B	V _R = 100 V; I _{FAV} = 1.4 A	SOD57
BYT52D	V _R = 200 V; I _{FAV} = 1.4 A	SOD57
BYT52G	V _R = 400 V; I _{FAV} = 1.4 A	SOD57
BYT52J	V _R = 600 V; I _{FAV} = 1.4 A	SOD57
BYT52K	V _R = 800 V; I _{FAV} = 1.4 A	SOD57
BYT52M	V _R = 1000 V; I _{FAV} = 1.4 A	SOD57

Absolute Maximum Ratings

 T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Sub type	Symbol	Value	Unit
Reverse voltage = Repetitive peak reverse	see electrical characteristics	BYT52A	V _R =	50	V
voltage			V_{RRM}		
	see electrical characteristics	BYT52B	V _R =	100	V
			V_{RRM}		
	see electrical characteristics	BYT52D	V _R =	200	V
			V_{RRM}		
	see electrical characteristics	BYT52G	V _R =	400	V
			V_{RRM}		
	see electrical characteristics	BYT52J	V _R =	600	V
			V_{RRM}		
	see electrical characteristics	BYT52K	V _R =	800	V
			V_{RRM}		
	see electrical characteristics	BYT52M	V _R =	1000	V
			V_{RRM}		

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Parameter	Test condition	Sub type	Symbol	Value	Unit
Peak forward surge current	t _p = 10 ms, half sinewave		I _{FSM}	50	Α
Average forward current	on PC board		I _{FAV}	0.85	Α
	I = 10 mm		I _{FAV}	1.4	Α
Junction and storage temperature range			$T_j = T_{stg}$	- 55 to + 175	°C
Non repetitive reverse avalanche energy	I _{(BR)R} = 0.4 A	BYT52J	E _R	10	mJ
	I _{(BR)R} = 0.4 A	BYT52K	E _R	10	mJ
	I _{(BR)R} = 0.4 A	BYT52M	E _R	10	mJ

Maximum Thermal Resistance

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Sub type	Symbol	Value	Unit
Junction ambient	I = 10 mm, T _L = constant		R_{thJA}	45	K/W
	on PC board with spacing 25 mm		R _{thJA}	100	K/W

Electrical Characteristics

 T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Sub type	Symbol	Min	Тур.	Max	Unit
Forward voltage	I _F = 1 A		V_{F}			1.3	V
Reverse current	$V_R = V_{RRM}$		I _R			5	μА
	$V_R = V_{RRM}, T_j = 150 ^{\circ}C$		I _R			150	μА
Reverse recovery time	I _F = 0.5 A, I _R = 1 A, i _R = 0.25 A		t _{rr}			200	ns

Typical Characteristics ($T_{amb} = 25$ °C unless otherwise specified)

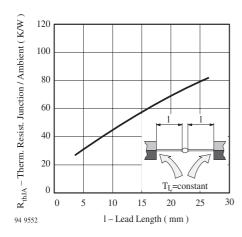


Figure 1. Max. Thermal Resistance vs. Lead Length

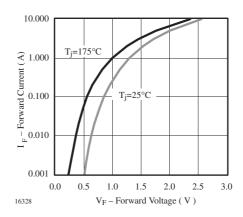


Figure 2. Forward Current vs. Forward Voltage



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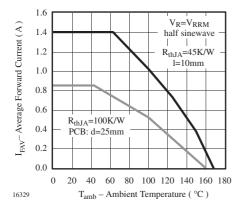


Figure 3. Max. Average Forward Current vs. Ambient Temperature

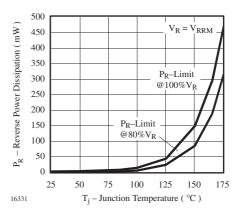


Figure 5. Max. Reverse Power Dissipation vs. Junction Temperature

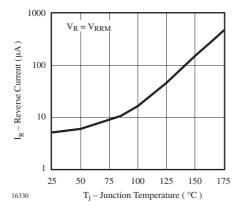


Figure 4. Reverse Current vs. Junction Temperature

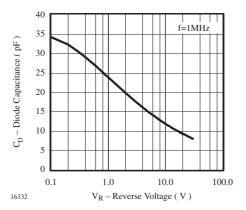
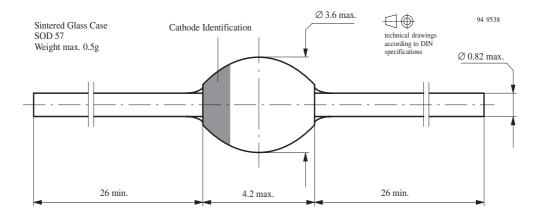


Figure 6. Diode Capacitance vs. Reverse Voltage

Package Dimensions in mm



BYT52.

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Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operatingsystems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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